

3.3-V DUAL PLL MULTICLOCK GENERATOR

FEATURES

- 27-MHz Master Clock Input
- Generated Audio System Clock:
 - SCKO0: $768 f_S$ ($f_S = 44.1$ kHz)
 - SCKO1: $384 f_S$, $768 f_S$ ($f_S = 44.1$ kHz)
 - SCKO2: $256 f_S$ ($f_S = 32, 44.1, 48, 64, 88.2, 96$ kHz)
 - SCKO3: $384 f_S$ ($f_S = 32, 44.1, 48, 64, 88.2, 96$ kHz)
- Zero PPM Error Output Clocks
- Low Clock Jitter: 50 ps (Typical)
- Multiple Sampling Frequencies:
 - $f_S = 32, 44.1, 48, 64, 88.2, 96$ kHz
- 3.3-V Single Power Supply
- PLL1705: Parallel Control
PLL1706: Serial Control
- Package: 20-Pin SSOP (150 mil), Lead-Free Product

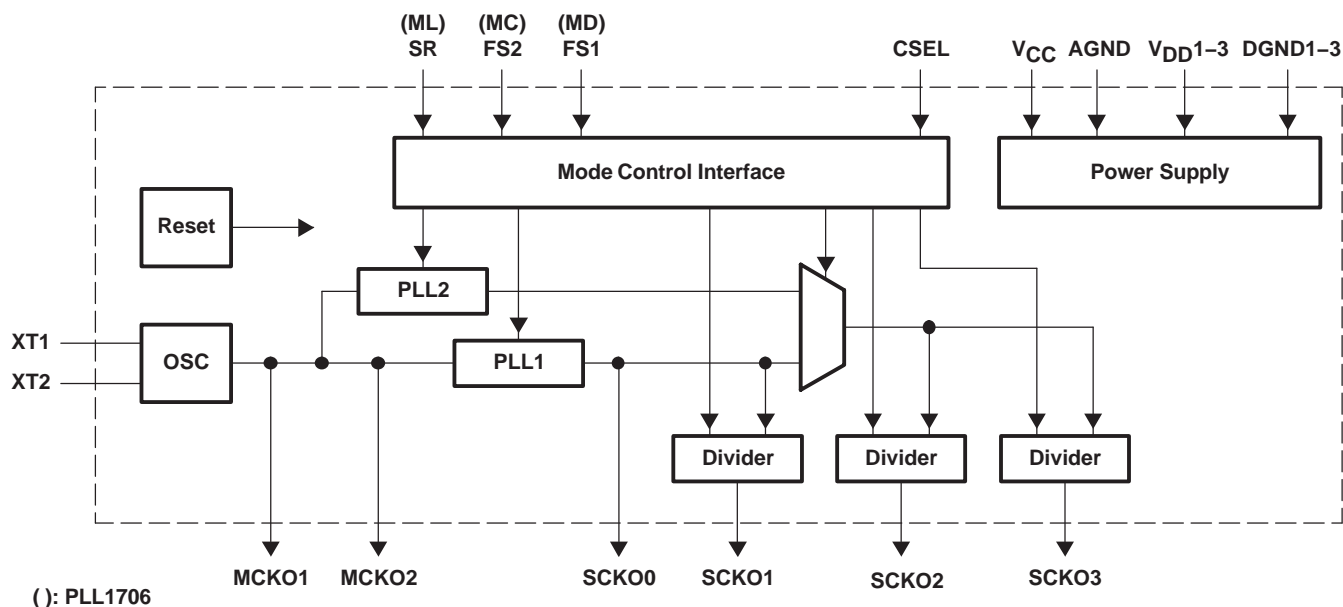
APPLICATIONS

- DVD Players
- DVD Add-On Cards for Multimedia PCs
- Digital HDTV Systems
- Set-Top Boxes

DESCRIPTION

The PLL1705[†] and PLL1706[†] are low cost, phase-locked loop (PLL) multiclock generators. The PLL1705 and PLL1706 can generate four system clocks from a 27-MHz reference input frequency. The clock outputs of the PLL1705 can be controlled by sampling frequency-control pins and those of the PLL1706 can be controlled through serial-mode control pins. The device gives customers both cost and space savings by eliminating external components and enables customers to achieve the very low-jitter performance needed for high performance audio DACs and/or ADCs. The PLL1705 and PLL1706 are ideal for MPEG-2 applications which use a 27-MHz master clock such as DVD players, DVD add-on cards for multimedia PCs, digital HDTV systems, and set-top boxes.

FUNCTIONAL BLOCK DIAGRAM



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

[†]The PLL1705 and PLL1706 use the same die and they are electrically identical except for mode control.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

PACKAGE/ORDERING INFORMATION

PRODUCT	PACKAGE	PACKAGE CODE	OPERATION TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
PLL1705DBQ	SSOP 20	20DBQ	–25°C to 85°C	PLL1705	PLL1705DBQ	Tube
					PLL1705DBQR	Tape and reel
PLL1706DBQ	SSOP 20	20DBQ	–25°C to 85°C	PLL1706	PLL1706DBQ	Tube
					PLL1706DBQR	Tape and reel

ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range unless otherwise noted⁽¹⁾

	PLL1705 AND PLL1706
Supply voltage: V_{CC} , V_{DD1-3}	4 V
Supply voltage differences: V_{CC} , V_{DD1-3}	± 0.1 V
Ground voltage differences: AGND, DGND1–3	± 0.1 V
Digital input voltage: FS1 (MD), FS2 (MC), SR (ML), CSEL	– 0.3 V to ($V_{DD} + 0.3$) V
Analog input voltage, XT1, XT2	– 0.3 V to ($V_{CC} + 0.3$) V
Input current (any pins except supplies)	± 10 mA
Ambient temperature under bias	–40°C to 125°C
Storage temperature	–55°C to 150°C
Junction temperature	150°C
Lead temperature (soldering)	260°C, 5 s
Package temperature (IR reflow, peak)	260°C

⁽¹⁾ Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

all specifications at $T_A = 25^\circ\text{C}$, $V_{DD1}-V_{DD3} (= V_{DD}) = V_{CC} = 3.3\text{ V}$, $f_M = 27\text{ MHz}$, crystal oscillation, $f_S = 48\text{ kHz}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT	
DIGITAL INPUT/OUTPUT							
Logic input			CMOS compatible				
V _{IH} ⁽¹⁾	Input logic level		0.7V _{DD}		3.6	V _{dc}	
V _{IL} ⁽¹⁾			0.3 V _{DD}				
I _{IH} ⁽¹⁾	Input logic current	V _{IN} = V _{DD}	65		100	μA	
I _{IL} ⁽¹⁾		V _{IN} = 0 V	±10				
Logic output			CMOS				
V _{OH} ⁽²⁾	Output logic level	I _{OH} = −4 mA	V _{DD} − 0.4 V			V _{dc}	
V _{OL} ⁽²⁾		I _{OL} = 4 mA	0.4			V _{dc}	
Sampling frequency		Standard f _S	32	44.1	48	kHz	
		Double f _S	64	88.2	96		
MASTER CLOCK (MCKO1, 2) CHARACTERISTICS (f _M = 27 MHz, C ₁ = C ₂ = 15 pF, C _L = 20 pF on measurement pin)							
Master clock frequency			26.73	27	27.27	MHz	
V _{IH}	Input level(3)		0.7 V _{CC}			V	
V _{IL}			0.3 V _{CC}				
I _{IH}	Input current(3)	V _{IN} = V _{CC}	±10			μA	
I _{IL}		V _{IN} = 0 V	±10				
Output voltage ⁽⁴⁾			3.5			V _{p-p}	
Output rise time		20% to 80% of V _{DD}	2.0			ns	
Output fall time		80% to 20% of V _{DD}	2.0			ns	
Duty cycle		For crystal oscillation	45%	48%	55%		
		For external clock	50%				
Clock jitter ⁽⁵⁾			50			ps	
Power-up time ⁽⁶⁾			0.5			1.5	ms
PLL AC CHARACTERISTICS (SCKO0–3) (f _M = 27 MHz, C _L = 20 pF on measurement pin)							
SCKO0	Output system clock frequency	Fixed	33.8688			MHz	
SCKO1		Selectable for 44.1 kHz	16.9344		33.8688		
SCKO2		256 f _S	8.192	12.288	24.576		
SCKO3		384 f _S	12.288	18.432	36.864		
Output rise time		20% to 80% of V _{DD}	2.0			ns	
Output fall time		80% to 20% of V _{DD}	2.0			ns	
Output duty cycle			45	50	55	%	
Output clock jitter ⁽⁵⁾			50			100	ps
Frequency Settling Time ⁽⁷⁾		PLL1705, to stated output frequency	50			150	ns
		PLL1706, to stated output frequency	80			200	ns
Power-up time ⁽⁸⁾		To stated output frequency	3			6	ms

(1) Pins 5, 6, 7, 12: FS1/MD, FS2/MC, SR/ML, CSEL (Schmitt-trigger input with internal pulldown, 3.3-V tolerant)

(2) Pins 2, 3, 14, 15, 18, 19: SCKO2, SCKO3, MCKO1, MCKO2, SCKO1, SCKO0

(3) Pin 10: XT1

(4) Pin 11: XT2

(5) Jitter performance is specified as standard deviation of jitter for 27-MHz crystal oscillation and default SCKO frequency setting. Jitter performance varies with master clock mode, SCKO frequency setting and load capacitance on each clock output.

(6) The delay time from power on to oscillation

(7) The settling time when the sampling frequency is changed

(8) The delay time from power on to lockup

(9) $f_M = 27\text{-MHz}$ crystal oscillation, no load on MCKO1, MCKO2, SCKO0, SCKO1, SCKO2, SCKO3. Power supply current varies with sampling frequency selection and load condition.

(10) While all bits of CE[6:1] are 0, the PLL1706 goes into power-down mode.

ELECTRICAL CHARACTERISTICS(continued)

all specifications at $T_A = 25^\circ\text{C}$, $V_{DD1}-V_{DD3} (= V_{DD}) = V_{CC} = 3.3\text{ V}$, $f_M = 27\text{ MHz}$, crystal oscillation, $f_S = 48\text{ kHz}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
POWER SUPPLY REQUIREMENTS						
V _{CC} , V _{DD}	Supply voltage range		2.7	3.3	3.6	V _{dc}
I _{DD} + I _{CC}	Supply current (9)	V _{DD} = V _{CC} = 3.3 V, f _S = 48 kHz		19	25	mA
		Power down(10)		320	500	μA
Power dissipation		V _{DD} = V _{CC} = 3.3 V, f _S = 48 kHz		63	90	mW
TEMPERATURE RANGE						
Operating temperature			−25		85	°C
θ _{JA}	Thermal resistance	PLL1705/6DBQ: 20-pin SSOP (150 mil)		150		°C/W

(1) Pins 5, 6, 7, 12: FS1/MD, FS2/MC, SR/ML, CSEL (Schmitt-trigger input with internal pulldown, 3.3-V tolerant)

(2) Pins 2, 3, 14, 15, 18, 19: SCKO2, SCKO3, MCKO1, MCKO2, SCKO1, SCKO0

(3) Pin 10: XT1

(4) Pin 11: XT2

(5) Jitter performance is specified as standard deviation of jitter for 27-MHz crystal oscillation and default SCKO frequency setting. Jitter performance varies with master clock mode, SCKO frequency setting and load capacitance on each clock output.

(6) The delay time from power on to oscillation

(7) The settling time when the sampling frequency is changed

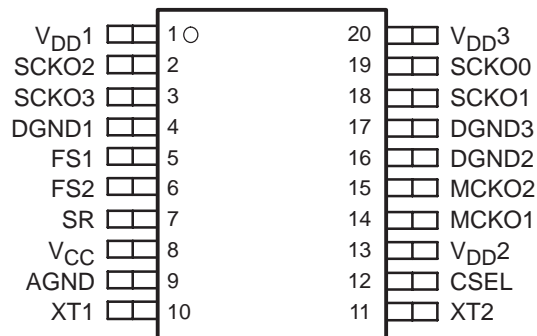
(8) The delay time from power on to lockup

(9) $f_M = 27\text{ MHz}$ crystal oscillation, no load on MCKO1, MCKO2, SCKO0, SCKO1, SCKO2, SCKO3. Power supply current varies with sampling frequency selection and load condition.

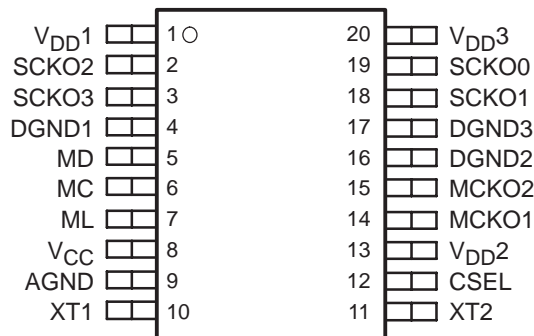
(10) While all bits of CE[6:1] are 0, the PLL1706 goes into power-down mode.

PIN ASSIGNMENTS

PLL1705
(TOP VIEW)



PLL1706
(TOP VIEW)



Terminal Functions

TERMINAL NAME	NO.	I/O	DESCRIPTION
AGND	9	–	Analog ground
CSEL	12	IN	SCKO1 frequency selection control ⁽¹⁾
DGND1	4	–	Digital ground 1
DGND2	16	–	Digital ground 2
DGND3	17	–	Digital ground 3
FS1(MD)	5	IN	Sampling frequency group control in PLL1705, data input for serial control in PLL1706 ⁽¹⁾
FS2(MC)	6	IN	Sampling frequency group control in PLL1705, bit clock input for serial control in PLL1706 ⁽¹⁾
MCKO1	14	OUT	27-MHz master clock output 1
MCKO2	15	OUT	27-MHz master clock output 2
SCKO0	19	OUT	System clock output 0 (33.8688 MHz fixed)
SCKO1	18	OUT	System clock output 1 (selectable for 44.1 kHz)
SCKO2	2	OUT	System clock output 2 (256 f _S)
SCKO3	3	OUT	System clock output 3 (384 f _S)
SR(ML)	7	IN	Sampling rate control in PLL1705, load strobe input for serial control in PLL1706 ⁽¹⁾
V _{CC}	8	–	Analog power supply, 3.3 V
V _{DD1}	1	–	Digital power supply 1, 3.3 V
V _{DD2}	13	–	Digital power supply 2, 3.3 V
V _{DD3}	20	–	Digital power supply 3, 3.3 V
XT1	10	IN	27-MHz crystal oscillator, or external clock input
XT2	11	OUT	27-MHz crystal oscillator, must be OPEN for external clock input mode

(1) Schmitt-trigger input with internal pulldown.

TYPICAL PERFORMANCE CURVES

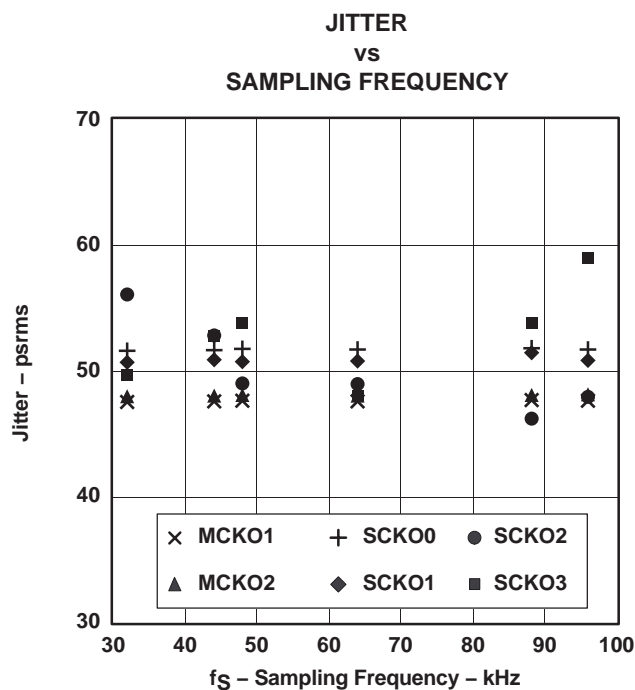


Figure 1

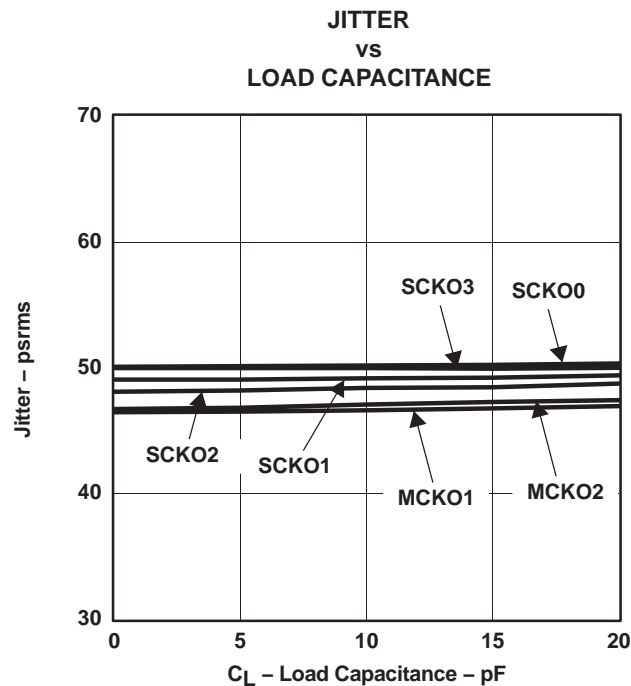


Figure 2

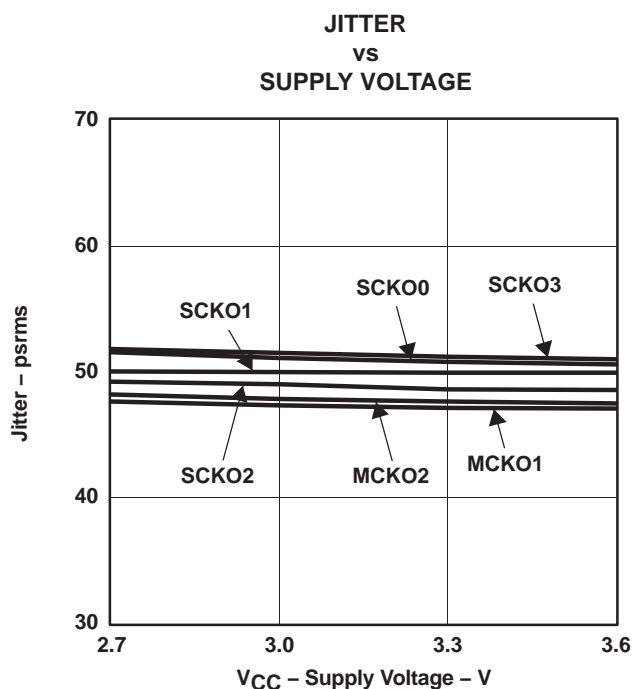


Figure 3

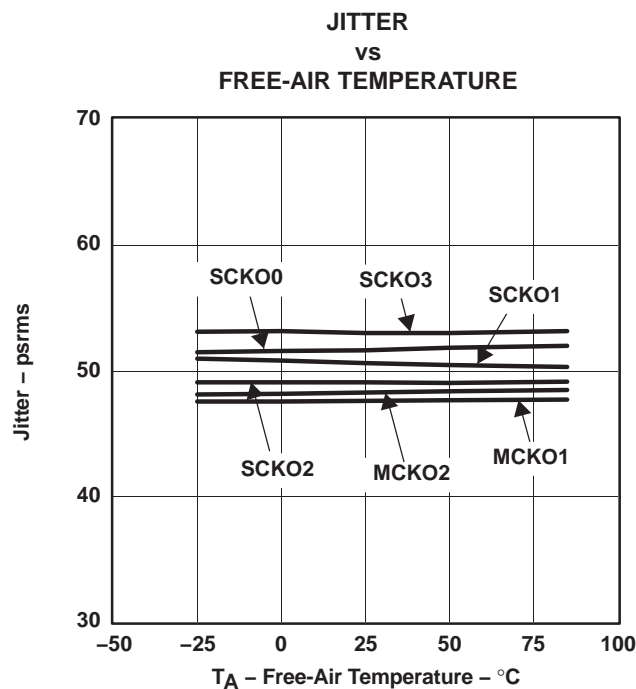


Figure 4

NOTE: All specifications at T_A = 25°C, V_{DD1-3} (= V_{DD}) = V_{CC} = +3.3 V, f_M = 27 MHz, crystal oscillation, C₁, C₂ = 15 pF, default frequency (33.8688 MHz for SCKO0, 33.8688 MHz for SCKO1, 256 f_S and 384 f_S of 48 kHz for SCKO2 and SCKO3), C_L = 20 pF on measurement pin, unless otherwise noted.

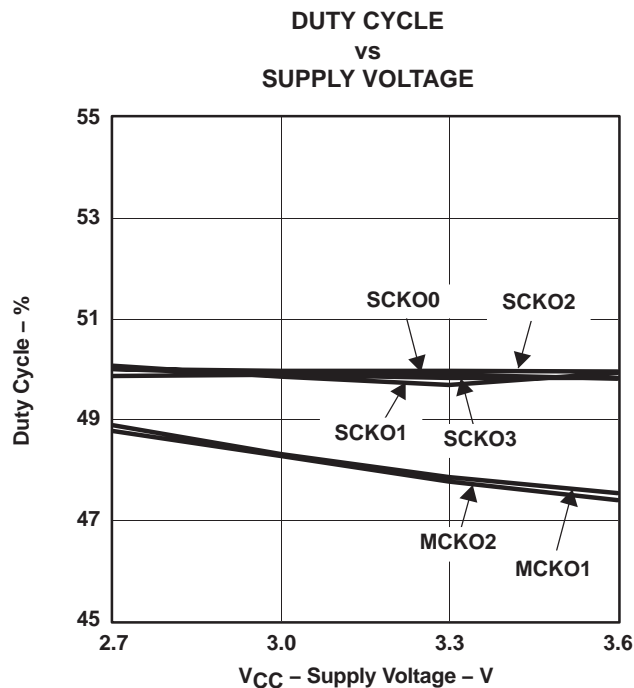


Figure 5

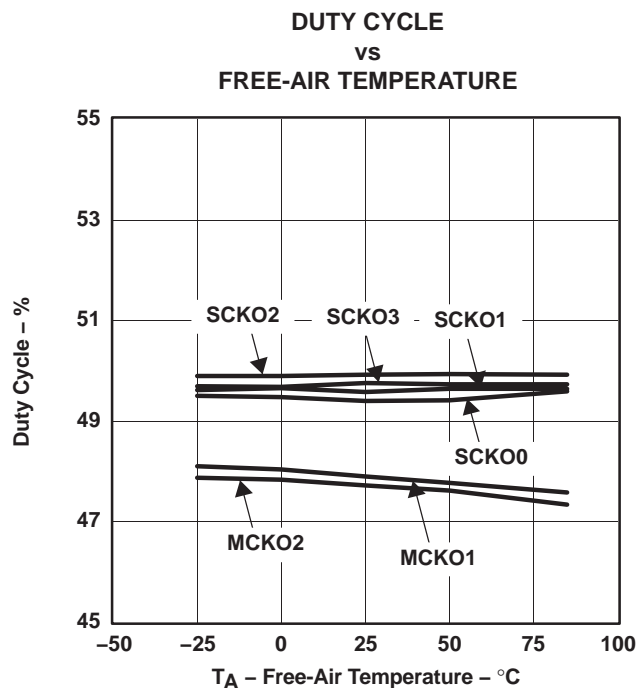


Figure 6

NOTE: All specifications at T_A = 25°C, V_{DD1-3} (= V_{DD}) = V_{CC} = +3.3 V, f_M = 27 MHz, crystal oscillation, C₁, C₂ = 15 pF, default frequency (33.8688 MHz for SCKO0, 33.8688 MHz for SCKO1, 256 f_S and 384 f_S of 48 kHz for SCKO2 and SCKO3), C_L = 20 pF on measurement pin, unless otherwise noted.

THEORY OF OPERATION

MASTER CLOCK AND SYSTEM CLOCK OUTPUT

The PLL1705/6 consists of a dual PLL clock and master clock generator which generates four system clocks and two buffered 27-MHz clocks from a 27-MHz master clock. Figure 7 shows the block diagram of the PLL1705/6. The PLL is designed to accept a 27-MHz master clock.

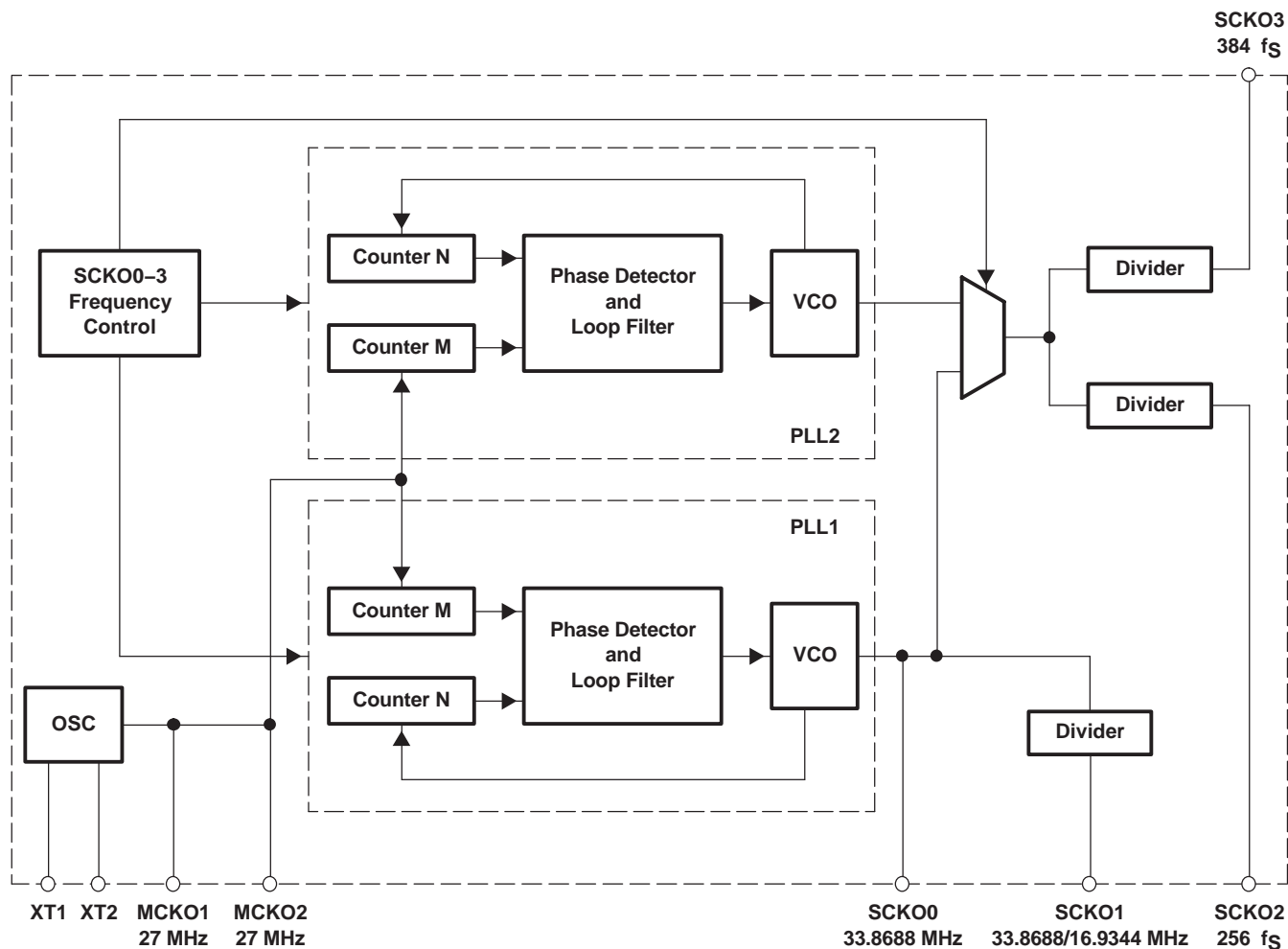


Figure 7. Block Diagram

The master clock can be either a crystal oscillator placed between XT1 (pin 10) and XT2 (pin 11), or an external input to XT1. If an external master clock is used, XT2 must be open. Figure 8 illustrates possible system clock connection options, and Figure 9 illustrates the 27-MHz master clock timing requirement.

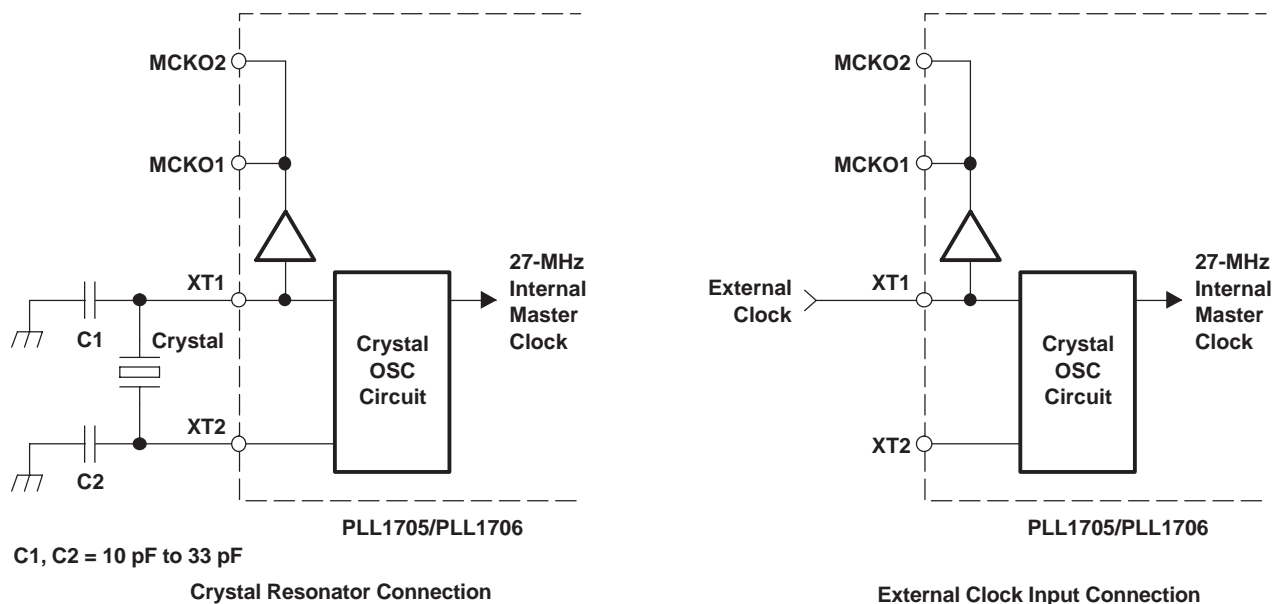
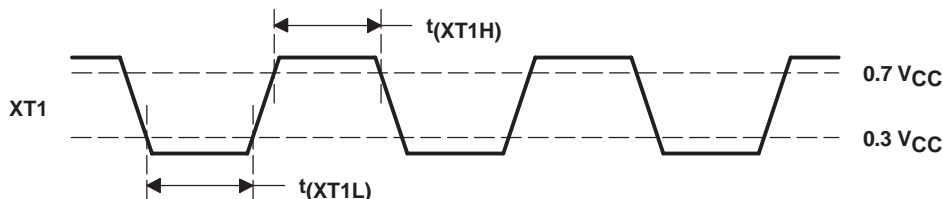


Figure 8. Master Clock Generator Connection Diagram



DESCRIPTION	SYMBOL	MIN	MAX	UNIT
Master clock pulse duration HIGH	t_{XT1H}	10		ns
Master clock pulse duration LOW	t_{XT1L}	10		ns

Figure 9. External Master Clock Timing Requirement

The PLL1705/6 provides a very low-jitter, high-accuracy clock. SCKO0 outputs a fixed 33.8688-MHz clock, SCKO1 outputs $384 f_S$ or $768 f_S$ ($f_S = 44.1$ kHz) which is selected by CSEL (pin 12) for a CD-DA DSP. The output frequency of the remaining clocks is determined by the sampling frequency (f_S) under hardware or software control. SCKO2 and SCKO3 output $256\text{-}f_S$ and $384\text{-}f_S$ system clocks, respectively. Table 2 shows each sampling frequency, which can be programmed. The system clock output frequencies for programmed sampling frequencies are shown in Table 3.

Table 1. Generated System Clock SCKO1 Frequency

CSEL	SCKO1 FREQUENCY
LOW	33.8688 MHz
HIGH	16.9344 MHz

Table 2. Sampling Frequencies

SAMPLING RATE	SAMPLING FREQUENCY (kHz)		
Standard sampling frequencies	32	44.1	48
Double sampling frequencies	64	88.2	96

Table 3. Sampling Frequencies and System Clock Output Frequencies

SAMPLING FREQUENCY (kHz)	SAMPLING RATE	SCKO2 (MHZ)	SCKO3 (MHZ)
32	Standard	8.192	12.288
44.1	Standard	11.2896	16.9344
48	Standard	12.288	18.432
64	Double	16.384	24.576
88.2	Double	22.5792	33.8688
96	Double	24.576	36.864

Response time from power on (or applying the clock to XT1) to SCKO settling time is typically 3 ms. Delay time from sampling frequency change to SCKO settling is 200 ns maximum. This clock transient timing is not synchronized with the SCKOx signals. Figure 10 illustrates SCKO transient timing in the PLL1706. External buffers are recommended on all output clocks in order to avoid degrading the jitter performance of the PLL1705/6.

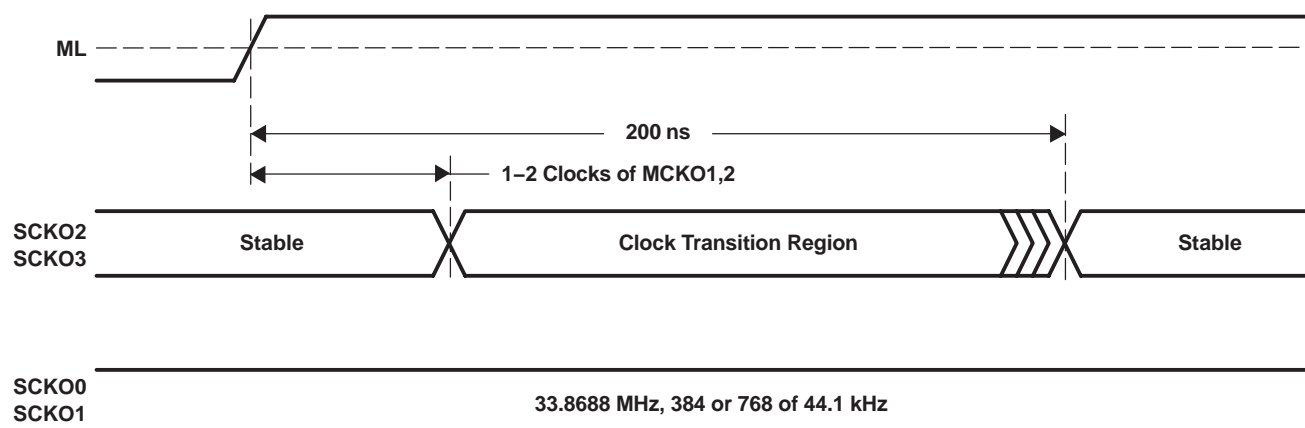


Figure 10. System Clock Transient Timing

POWER-ON RESET

The PLL1705/6 has an internal power-on reset circuit. The mode register of PLL1706 is initialized with default settings by power-on reset. Throughout the reset period, all clock outputs are enabled with the default settings after power up time. Initialization by internal power-on reset is done automatically during 1024 master clocks at $V_{DD} > 2.0$ V (TYP). Power-on reset timing is shown in Figure 11.

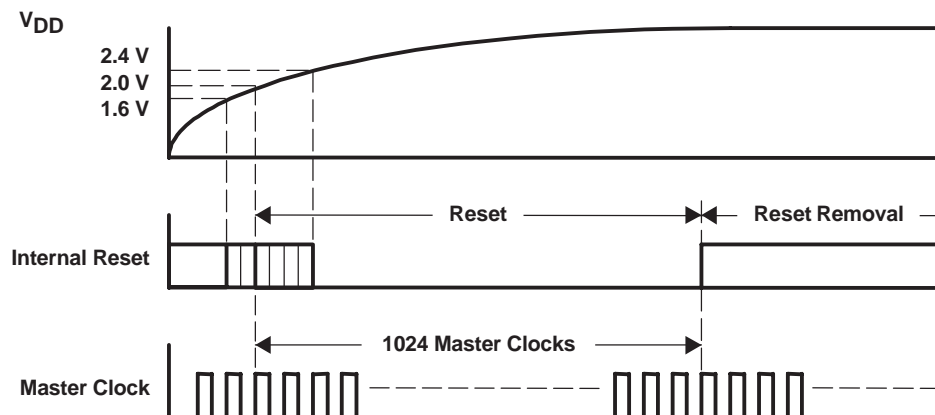


Figure 11. Power-On Reset Timing

FUNCTION CONTROL

The built-in functions of the PLL1705 can be controlled in the parallel mode (hardware mode), which uses SR (pin 7), FS1 (pin 5) and FS2 (pin 6). The PLL1706 can be controlled in the serial mode (software mode), which uses a three-wire interface by ML (pin 7), MC (pin 6), and MD (pin 5). The selectable functions are shown in Table 4.

Table 4. Selectable Functions

SELECTABLE FUNCTION	PARALLEL MODE	SERIAL MODE
Sampling frequency select (32 kHz, 44.1 kHz, 48 kHz)	Yes	Yes
Sampling rate select (standard/double)	Yes	Yes
Each clock output enable/disable	No	Yes
Power down	No	Yes

PLL1705 (Parallel Mode)

In the parallel mode, the following functions can be selected:

Sampling Frequency Group Select

The sampling frequency group can be selected by FS1 (pin 5) and FS2 (pin 6).

FS2 (PIN 6)	FS1 (PIN 5)	SAMPLING FREQUENCY
LOW	LOW	48 kHz
LOW	HIGH	44.1 kHz
HIGH	LOW	32 kHz
HIGH	HIGH	Reserved

Sampling Rate Select

The sampling rate can be selected by SR (pin 7)

SR (PIN 7)	SAMPLING RATE
LOW	Standard
HIGH	Double

PLL1706 (Serial Mode)

The built-in functions of the PLL1706 are shown in Table 5. These functions are controlled using the ML, MC, and MD serial control signals.

Table 5. Selectable Functions

SELECTABLE FUNCTION	DEFAULT
Sampling frequency select (32 kHz, 44.1 kHz, 48 kHz)	48-kHz group
Sampling rate select (standard/double)	Standard
Each clock output enable/disable	Enabled
Power down	Disabled

Program-Register Bit Mapping

The built-in functions of the PLL1706 are controlled through a 16-bit program register. This register is loaded using MD, MC and ML. After the 16 data bits are clocked in using the rising edge of MC, ML is used to latch the data into the register. Table 6 shows the bit mapping of the register. The serial mode control format and control data input timing are shown in Figure 12 and Figure 13, respectively.

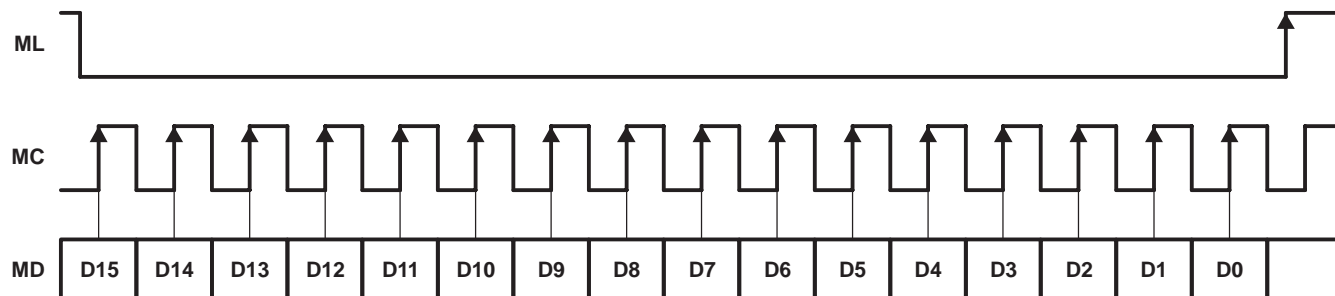
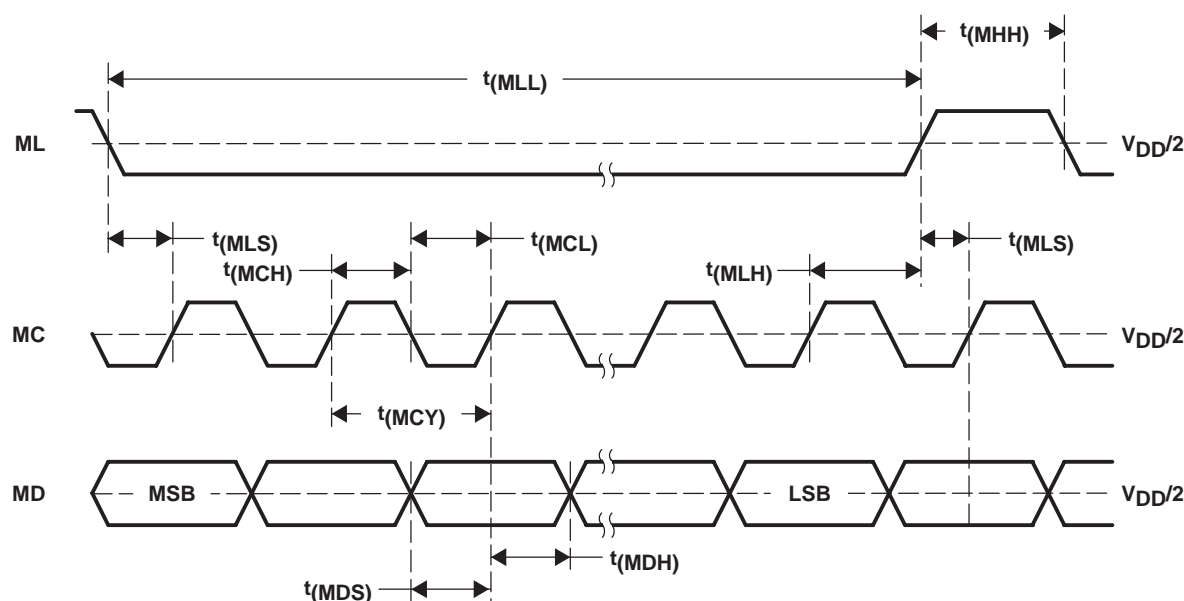


Figure 12. Serial Mode Control Format



DESCRIPTION	SYMBOL	MIN	TYP	MAX	UNIT
MC pulse cycle time	t_{MCY}	100			ns
MC pulse duration LOW	t_{MCL}	40			ns
MC pulse duration HIGH	t_{MCH}	40			ns
MD hold time	t_{MDH}	40			ns
MD setup time	t_{MDS}	40			ns
ML low-level time	t_{MLL}	16			MC clocks ⁽¹⁾
ML high-level time	t_{MHH}	200			ns
ML hold time ⁽²⁾	t_{MLH}	40			ns
ML setup time ⁽³⁾	t_{MLS}	40			ns

(1) MC clocks: MC clock period

(2) MC rising edge for LSB to ML rising edge

(3) ML rising edge to the next MC rising edge. If the MC clock is stopped after the LSB, any ML rise time is accepted.

Figure 13. Control Data Input Timing

Mode Register

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
0	1	1	1	0	0	CE6	CE5	CE4	CE3	CE2	CE1	RSV	SR	FS2	FS1

Table 6. Register Mapping

REGISTER	BIT NAME	DESCRIPTION
Mode control	CE6	MCKO2 output enable/disable
	CE5	MCKO1 output enable/disable
	CE4	SCKO1 output enable/disable
	CE3	SCKO3 output enable/disable
	CE2	SCKO2 output enable/disable
	CE1	SCKO0 output enable/disable
	RSV	Reserved, must be 0
	SR	Sampling rate select
	FS[2:1]	Sampling frequency select

FS[2:1]: Sampling Frequency Group Select

FS2	FS1	SAMPLING FREQUENCY	DEFAULT
0	0	48 kHz	0
0	1	44.1 kHz	
1	0	32 kHz	
1	1	Reserved	

SR: Sampling Rate Select

SR	SAMPLING RATE	DEFAULT
0	Standard	0
1	Double	

CE [6:1]: Clock Output Control

CE1–CE6	CLOCK OUTPUT CONTROL	DEFAULT
0	Clock output disable	
1	Clock output enable	0

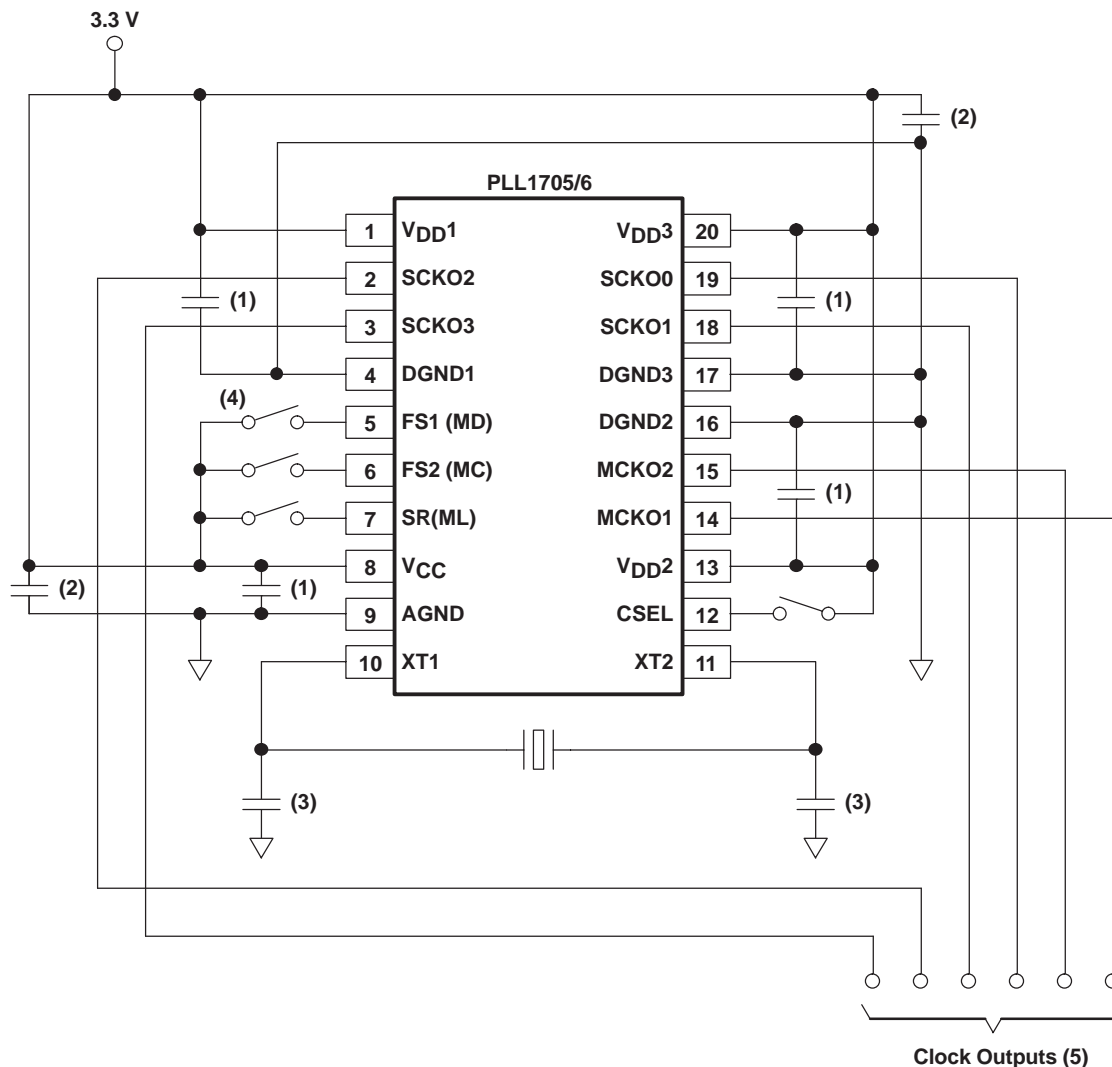
While all the bits of CE [6:1] are 0, the PLL1706 goes into the power-down mode, all dynamic operation including PLLs and the oscillator halt, but serial mode control is enabled for resumption.

CONNECTION DIAGRAM

Figure 14 shows the typical connection circuit for the PLL1705. There are four grounds for digital and analog power supplies. However, the use of one common ground connection is recommended to avoid latch-up or other power-supply-related troubles. Power supplies should be bypassed as close as possible to the device.

MPEG-2 APPLICATIONS

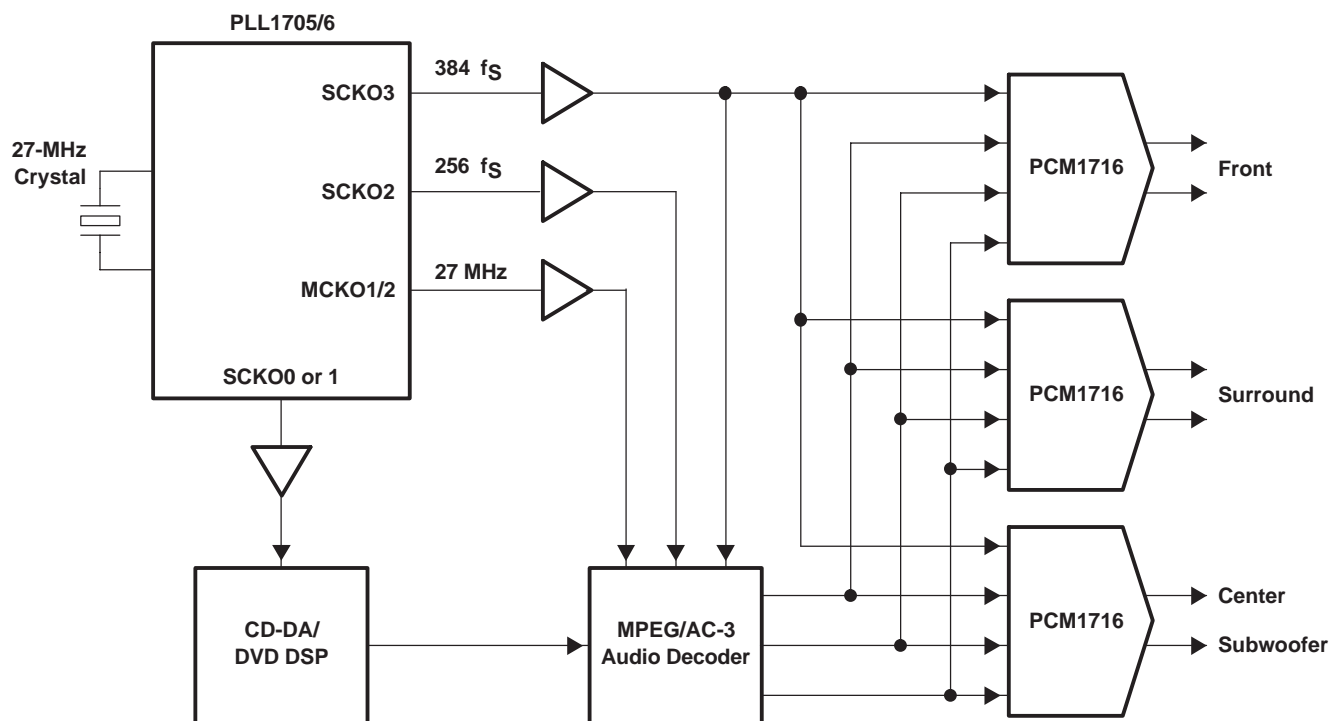
Typical applications for the PLL1705/6 are MPEG-2 based systems such as DVD players, DVD add-on cards for multimedia PCs, digital HDTV systems, and set-top boxes. The PLL1705/6 provides audio system clocks for a CD-DA DSP, DVD DSP, Karaoke DSP, and DAC(s) from a 27-MHz video clock.



- (1) 0.1-μF ceramic capacitor typical, depending on quality of power supply and pattern layout
- (2) 10-μF aluminum electrolytic capacitor typical, depending on quality of power supply and pattern layout
- (3) 27-MHz quartz crystal and 10–33 pF × 2 ceramic capacitors, which generate the appropriate amplitude of oscillation on XT1/XT2
- (4) This connection is for PLL1705 (parallel mode); when PLL1706 (serial mode) is to be used, control pins must be connected to serial interfaced controller.
- (5) For good jitter performance, minimize the load capacitance on the clock output.

Figure 14. Typical Connection Diagram

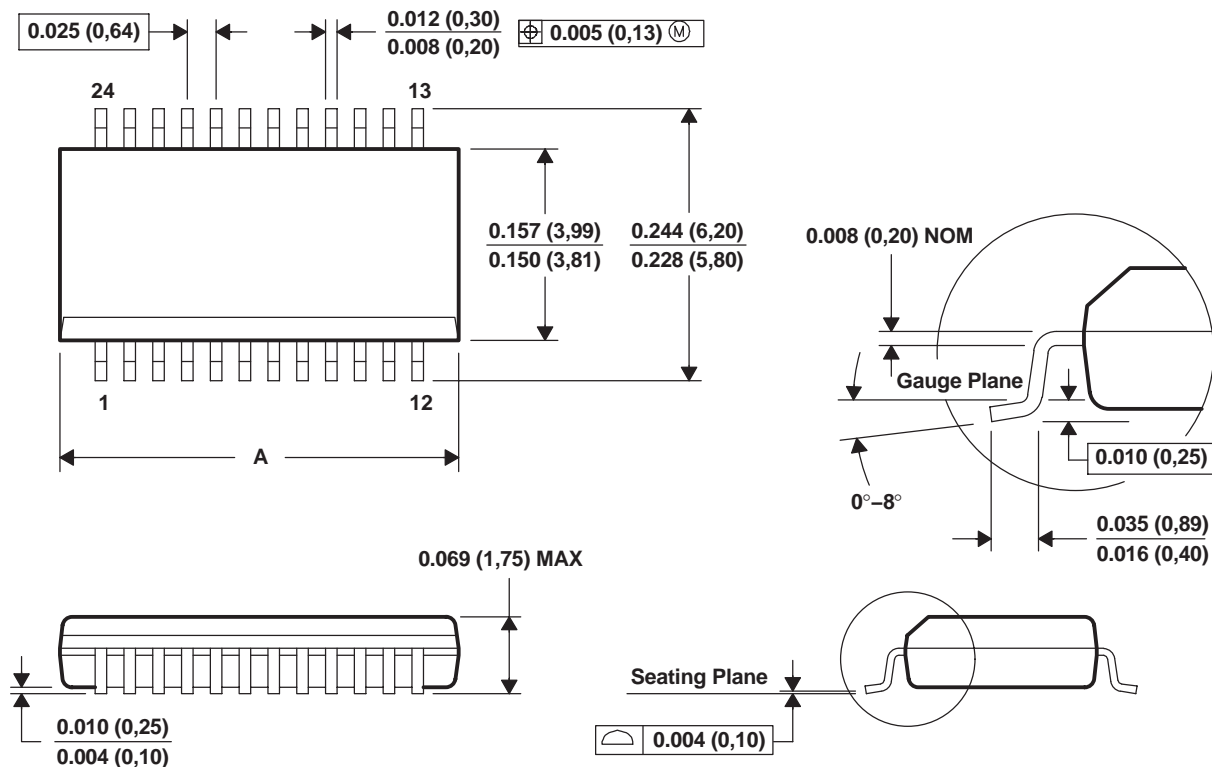
BLOCK DIAGRAM OF MPEG-2 BASED SYSTEM APPLICATION



MECHANICAL DATA

DBQ (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE



4073301/F 02/02

NOTES:A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MO-137.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
PLL1705DBQ	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1705DBQ.B	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1705DBQR	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1705DBQR.B	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1705DBQRG4	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1705DBQRG4.B	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1705 TC
PLL1706DBQ	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC
PLL1706DBQ.B	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC
PLL1706DBQG4	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC
PLL1706DBQG4.B	Active	Production	SSOP (DBQ) 20	50 TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC
PLL1706DBQR	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC
PLL1706DBQR.B	Active	Production	SSOP (DBQ) 20	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-25 to 85	PLL1706 TC

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
PLL1705DBQR	SSOP	DBQ	20	2000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
PLL1705DBQRG4	SSOP	DBQ	20	2000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
PLL1706DBQR	SSOP	DBQ	20	2000	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
PLL1705DBQR	SSOP	DBQ	20	2000	353.0	353.0	32.0
PLL1705DBQRG4	SSOP	DBQ	20	2000	353.0	353.0	32.0
PLL1706DBQR	SSOP	DBQ	20	2000	353.0	353.0	32.0

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
PLL1705DBQ	DBQ	SSOP	20	50	506.6	8	3940	4.32
PLL1705DBQ.B	DBQ	SSOP	20	50	506.6	8	3940	4.32
PLL1706DBQ	DBQ	SSOP	20	50	506.6	8	3940	4.32
PLL1706DBQ.B	DBQ	SSOP	20	50	506.6	8	3940	4.32
PLL1706DBQG4	DBQ	SSOP	20	50	506.6	8	3940	4.32
PLL1706DBQG4.B	DBQ	SSOP	20	50	506.6	8	3940	4.32

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